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Variant/Label Table

<table>
<thead>
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<th>Variant</th>
<th>Label Text</th>
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<tbody>
<tr>
<td>001</td>
<td>ChangeMe!</td>
</tr>
<tr>
<td>002</td>
<td>ChangeMe!</td>
</tr>
</tbody>
</table>

Assembly Note

- ZZ1: These assemblies are ESD sensitive, ESD precautions shall be observed.
- ZZ2: These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- ZZ3: These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
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